## **MOSFET** – N-Channel, SUPERFET<sup>®</sup> II

## 600 V, 75 A, 43 m $\Omega$

# FCH043N60

## Description

SUPERFET II MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.

### Features

- Typ.  $R_{DS(on)} = 37 \text{ m}\Omega$
- $600 \text{ V} @ \text{T}_{\text{J}} = 150^{\circ}\text{C}$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 163 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 730 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

#### Applications

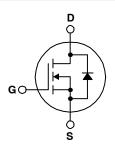
- Telecom / Sever Power Supplies
- Industrial Power Supplies



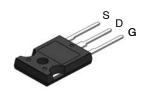
## **ON Semiconductor®**

### www.onsemi.com

V <sub>DS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
600 V	43 mΩ @ 10 V	75 A

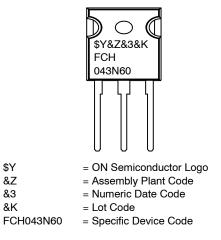


**N-CHANNEL MOSFET** 



TO-247-3LD CASE 340CK

#### MARKING DIAGRAM



### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter		FCH043N60	Unit			
V <sub>DSS</sub>	Drain to Source Voltage		600	V			
V <sub>GSS</sub>	Gate to Source Voltage	– DC	±20	V			
		– AC (f > 1 Hz)	±30				
I <sub>D</sub>	Drain Current:	– Continuous (T <sub>C</sub> = 25°C)	75	A			
		– Continuous (T <sub>C</sub> = 100°C)	47.5				
I <sub>DM</sub>	Drain Current: – Pulsed (Note 1)	I <sub>DM</sub> Drain Current: - Pulsed (Note 1)	– Pulsed (Note 1)	rrent: - Pulsed (Note 1)	225	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)	<b>3</b> , ( )		mJ			
I <sub>AR</sub>	Avalanche Current (Note 1)			A			
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		5.92	mJ			
dv/dt	MOSFET dv/dt		100	V/ns			
	Peak Diode Recovery dv/dt (Note 3)		20				
PD	Power Dissipation	(T <sub>C</sub> = 25°C)	592	W			
		- Derate Above 25°C	4.74	W/°C			
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to + 150	°C			
ΤL	Maximum Lead Temperature for Soldering, 1/	/8″ from Case for 5 seconds	300	°C			

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality shows be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 15 \text{ A}, \text{ R}_{G} = 25 \Omega$ , Starting  $T_{J} = 25 \text{ °C}$ . 3.  $I_{SD} \leq 38 \text{ A}, \text{ di/dt} \leq 200 \text{ A/}\mu\text{s}, \text{ V}_{DD} \leq 380 \text{ V}, \text{ Starting } T_{J} = 25 \text{ °C}.$ 

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH043N60	FCH043N60	TO-247	Tube	N/A	N/A	30 Units

#### **THERMAL CHARACTERISTICS**

Symbol	Parameter	FCH043N60	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.21	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	

### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit		
OFF CHARACTERISTICS								
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D$ = 10 mA, $V_{GS}$ = 0 V, $T_J$ = 25°C	600	-	-	V		
		$I_D$ = 10 mA, $V_{GS}$ = 0 V, $T_J$ = 150°C	650	-	-			
$\Delta {\sf BV}_{\sf DSS}$ / $\Delta {\sf T}_{\sf J}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 10 mA, Referenced to 25°C	-	0.67	-	V/°C		
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA		
		$V_{DS}$ = 480 V, $V_{GS}$ = 0 V, $T_{C}$ = 125 $^{\circ}C$	-	4.5	-			
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V	-	-	±100	nA		
ON CHARA	CTERISTICS							

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}=V_{DS},I_{D}=250\;\mu A$	2.5	-	3.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS}$ = 10 V, I <sub>D</sub> = 38 A	-	37	43	mΩ
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 38 \text{ A}$	-	73	-	S

## DYNAMIC CHARACTERISTICS

C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 1 MHz	-	9194	12225	pF
C <sub>oss</sub>	Output Capacitance		-	353	470	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	11	16	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V	-	730	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	$V_{DS} = 380 \text{ V}, \text{ I}_{D} = 38 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	-	163	215	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	(Note 4)	-	35	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		-	39	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	1.1	-	Ω

SWITCHING CHARACTERISTICS

t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 38 \text{ A},$	-	46	102	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> = 10 V, R <sub>g</sub> = 4.7 Ω (Note 4)	_	36	82	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	162	334	ns
t <sub>f</sub>	Turn-Off Fall Time		-	6	-	ns

**DRAIN-SOURCE DIODE CHARACTERISTICS** 

۱ <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current		-	-	75	А
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	225	А
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 38 \text{ A}$	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 38 A,$	-	605	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	dl <sub>F</sub> /dt = 100 Α/μs	-	16	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature.

### **TYPICAL CHARACTERISTICS**

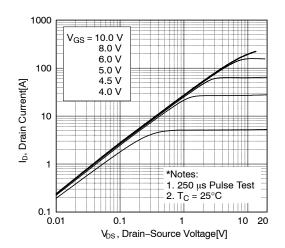


Figure 1. On-Region Characteristics

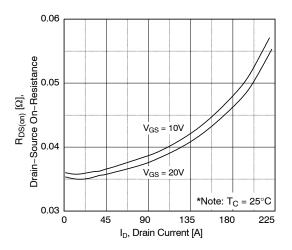


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

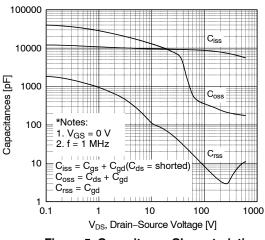


Figure 5. Capacitance Characteristics

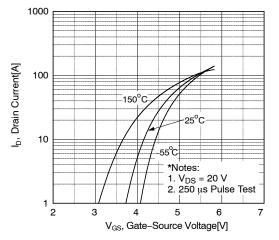


Figure 2. Transfer Characteristics

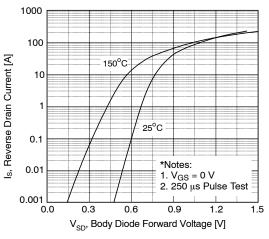


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

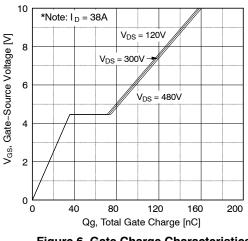
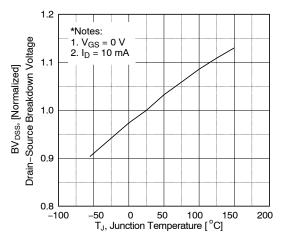
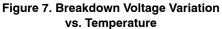


Figure 6. Gate Charge Characteristics

## **TYPICAL CHARACTERISTICS**





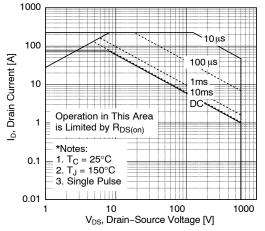
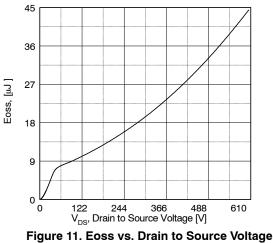


Figure 9. Maximum Safe Operating Area



Switching Capability

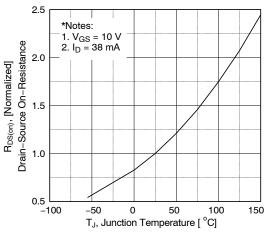
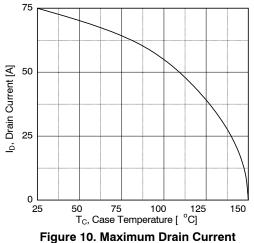


Figure 8. On–Resistance Variation vs. Temperature



vs. Case Temperature

## **TYPICAL CHARACTERISTICS**

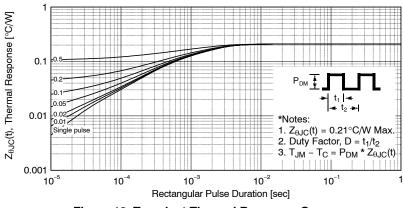
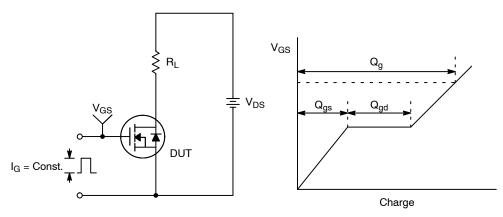


Figure 12. Transient Thermal Response Curve





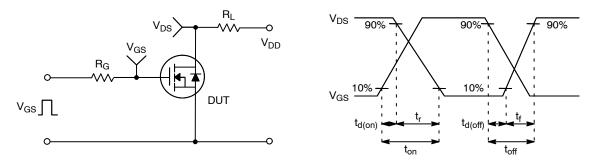


Figure 14. Resistive Switching Test Circuit & Waveforms

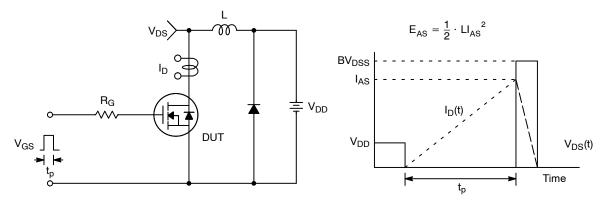


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

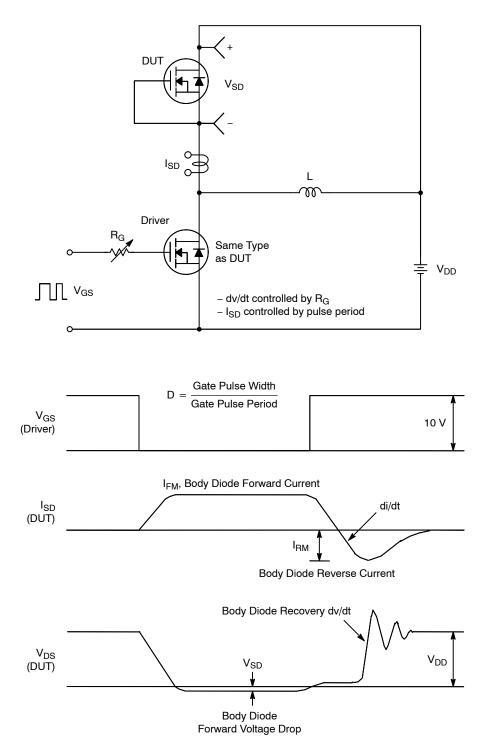


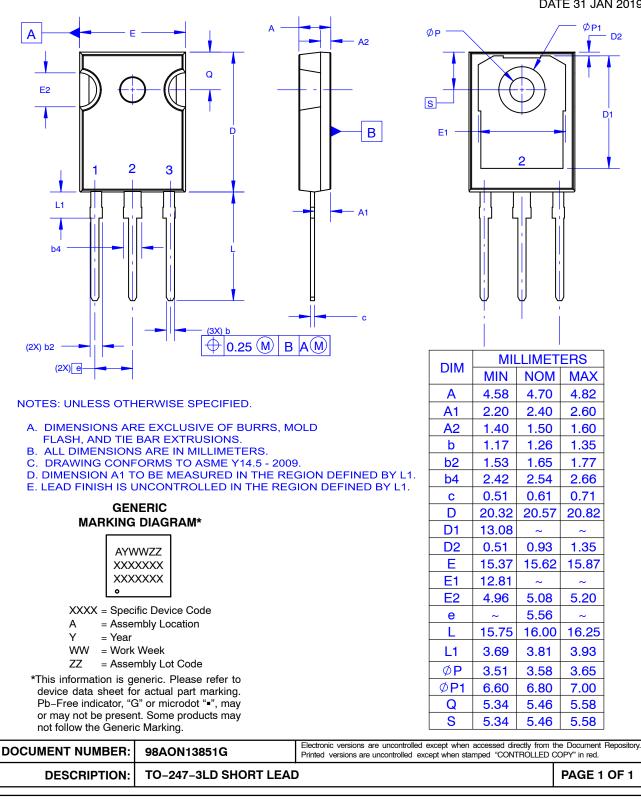
Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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DATE 31 JAN 2019



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